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SEMICONDUCTOR®

FDT86102LZ N-Channel PowerTrench[®] MOSFET 100 V, 6.6 A, 28 m Ω

Features

- Max $r_{DS(on)} = 28 \text{ m}\Omega \text{ at } V_{GS} = 10 \text{ V}, I_D = 6.6 \text{ A}$
- Max r_{DS(on)} = 38 mΩ at V_{GS} = 4.5 V, I_D = 5.5 A
- HBM ESD protection level > 6 kV typical (Note 4)
- Very low Qg and Qgd compared to competing trench technologies
- Fast switching speed
- 100% UIL Tested
- RoHS Compliant

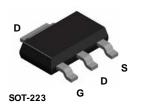


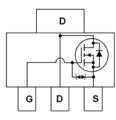
General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that has been especially tailored to minimize the on-state resistance and switching loss. G-S zener has been added to enhance ESD voltage level.

Applications

- DC-DC conversion
- Inverter
- Synchronous Rectifier





MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units		
V _{DS}	Drain to Source Voltage			100	V		
V _{GS}	Gate to Source Voltage			±20	V		
	Drain Current -Continuous			6.6	•		
D	-Pulsed			40	— A		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	84	mJ		
D	Power Dissipation	T _A = 25 °C	(Note 1a)	2.2	w		
P _D	Power Dissipation	T _A = 25 °C	(Note 1b)	1.0	vv		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C		

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	(Note 1)	12	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	55	C/vv

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
86102LZ	FDT86102LZ	SOT-223	13 "	12 mm	2500 units

FDT86102LZ N-Channel PowerTrench[®] MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0 \ V$	100			V
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		70		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 80 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$	1.0	1.4	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		-6		mV/°C
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 6.6 A		22	28	
		V _{GS} = 4.5 V, I _D = 5.5 A		27	38	mΩ
		V _{GS} = 10 V, I _D = 6.6 A, T _J = 125 °C		36	46	-
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 6.6 A		26		S
Dynamic	Characteristics					
C _{iss}	Input Capacitance	V 50.V.V. 0.V.		1118	1490	pF
C _{oss}	Output Capacitance	── V _{DS} = 50 V, V _{GS} = 0 V, f = 1MHz		181	245	pF
C _{rss}	Reverse Transfer Capacitance			7.5	15	pF
R _g	Gate Resistance			0.5		Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			6.6	14	ns
t _r	Rise Time	V _{DD} = 50 V, I _D = 6.6 A,		1.9	10	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		19	31	ns
t _f	Fall Time			2.2	10	ns
Q _{g(TOT)}	Total Gate Charge	V _{GS} = 0 V to 10 V		17	25	nC
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 \text{ V to } 4.5 \text{ V} \text{ V}_{DD} = 50 \text{ V},$		8.3	12	
Q _{gs}	Gate to Source Charge	I _D = 6.6 A		2.6		nC
Q _{gd}	Gate to Drain "Miller" Charge			2.2		nC

Drain-Source Diode Characteristics

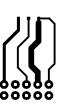
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 6.6 A$	(Note 2)	0.82	1.3	V
		$V_{GS} = 0 V, I_{S} = 1 A$	(Note 2)	0.68	1.2	
t _{rr}	Reverse Recovery Time	I _F = 6.6 A, di/dt = 100 A/μs		40	64	ns
Q _{rr}	Reverse Recovery Charge			36	58	nC

NOTES:

1. R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



a) 55 °C/W when mounted on a 1 in² pad of 2 oz copper

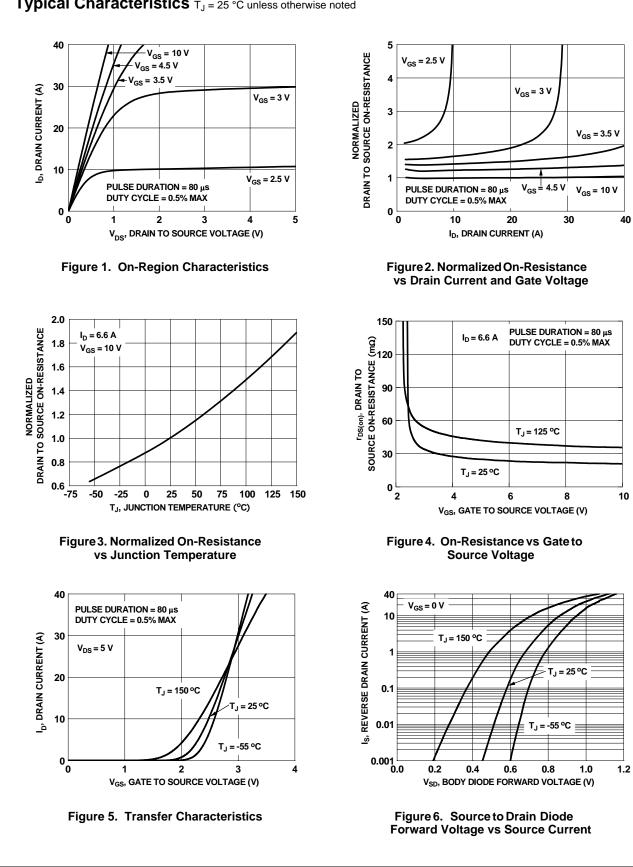


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b) 118 °C/W when mounted on a minimum pad of 2 oz copper

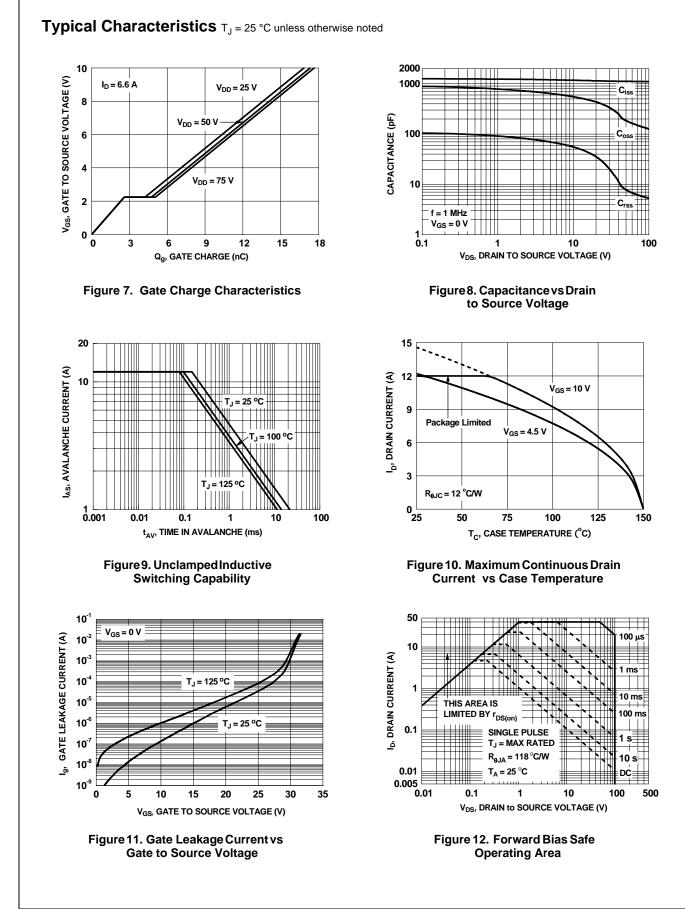
Pulse Test: Pulse Width < 300 μs, Duty cycle < 2.0 %.
Starting T_J = 25 °C, L = 1 mH, I_{AS} = 13 A, V_{DD} = 90 V, V_{GS} = 10 V.
The diode connected between gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

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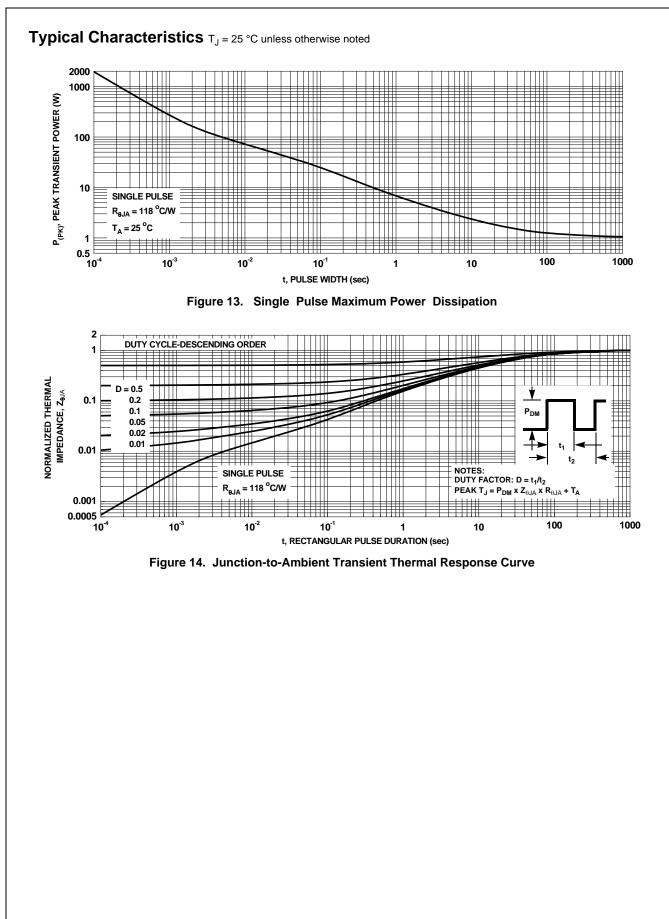


Typical Characteristics T_J = 25 °C unless otherwise noted

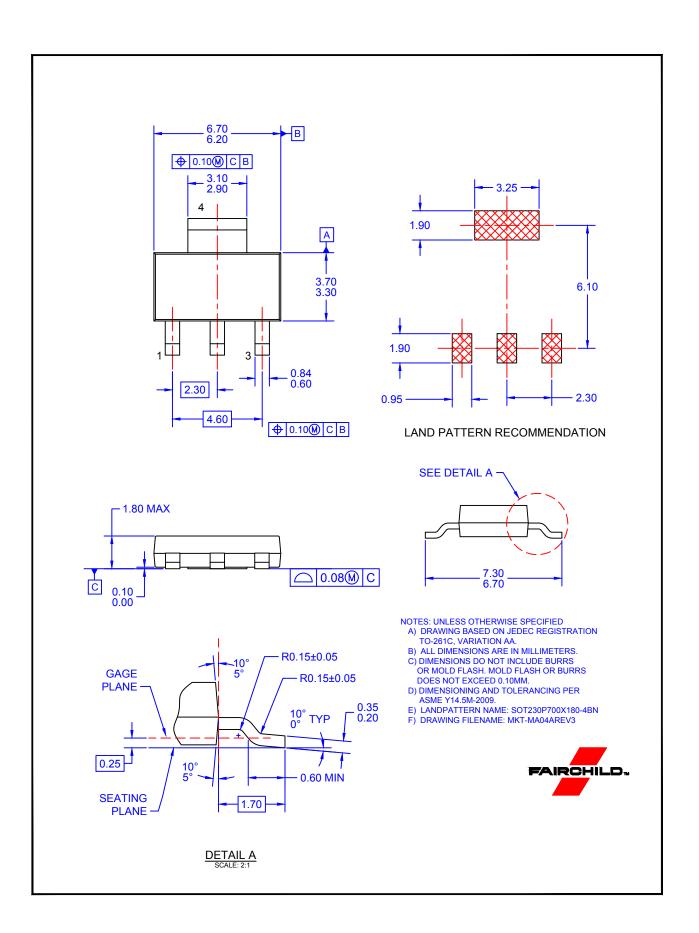




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5



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